

Tescan EXLO 1200

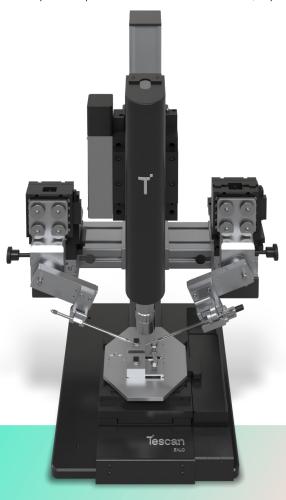
TESCAN EXLO 1200 is our most advanced ex situ lift-out system to date-designed for fast, easy, and reproducible manipulation of FIB-prepared S/TEM specimens.

Each TESCAN EXLO 1200 system includes motorized focus control, motorized lens changer and zoom, motorized XYZR manipulator with rotation, glass tip puller, active suspension, and a flexible graphical user software interface for semi-automated ex situ manipulation. The system can handle sample sizes (e.g., wafers or small pieces of samples) of up to 300 mm in diameter and offers the flexibility of adding a second XYZ motorized manipulator.

The partocal zoom microscope provides an unprecedented and continuous horizontal field of view from ~ 3 mm down to 60 μ m-enabling precise visual control throughout the manipulation process. The UI can import or export a text file or CSV file of saved X, Y specimen

coordinates. Global and nested saves are available for any motor or stage position for semi-automated operation from specimen to grid and back.

The TESCAN EXLO 1200 is perfect for exsitu lift out of several tens of specimens per hour and can support multiple FIB instruments. When bundled with TESCAN's TEM AutoPrep Pro™ for preparing unattended specimens for S/TEM analysis, the system can significantly increase throughput and decrease the cost per specimen.



Optional accessories further enhance the system's versatility:

Tescan EXLO 1200

for Semiconductors

- The Pick&Place™ holder simplifies ex situ lift-out handling.
- The Aspirato™ module offers vacuum-assisted ex situ manipulation for delicate operations.
- EXpressLO™ PGrids allow for front-side or back-side ex situ lift-out of various specimen sizes without the need for a carbon support film.
- EXpressLO-ZTM grids, made from nanocrystalline diamond, minimize X-ray overlap interference, reduce fluorescence and Bremsstrahlung during EDS analysis, and improve data quality.



ex situ lift-out



Parfocal



Programmable joystick



Autofocus



Rotational micromanipulator



center RC



300 mm wafer sample



Remote



Product Specifications

Stage

Motorized stage travel (X & Y)	300 x 300 mm
Maximum specimen height	137 mm
Maximum specimen size	> 300 mm
Maximum specimen weight (XY moves)	81 kg

Optics

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Horizontal field width (HFW)	60 µm to 3 mm
Working distance	20 mm
Resolution	<1µm
Light source	LED
Motorized focus travel	100 mm

Image acquisition

Maximum frame size (px x px)	1284 x 1024		
Image and video formats	JPG/BMP/TIF/PNG/		
	AVI		

Camera

Camera USB3

Manipulator

Single motorized micromanipulator	
XYZ travel	25 mm
Omnidirectional repeatability (XYZ)	1 µm
Maximum and minimum velocities	1 µm/s to 5 mm/s
Minimum step size	1 µm
Continuous 360° rotation	
Precision of rotation	1°
Compucentric rotation	
Mouse gesture control	
2 nd manipulator (non-rotational)	Optional
Coordinate system transfer format	CSV/TXT

User interface

Control PC	Intel Core i5-14400, 10-core 4.7 GHz, RAM1 x 8 GB DDR5 4800 MHz, 515 GB SSD M.2, GPU Intel UHD 730, Windows 11 Pro 64-bit
Keyboard and mouse	
Monitor	32"
Programmable joystick with buttons (mode	el) X-Keys
EXpressLO graphical user interface	

EXpressLO software

Multiuser account management
Global icon saves
Nested saves
Click to center region of interest
Autofocus
Read/save positions from/to file
Unified UI for joystick programming
Video recording

Other accessories

Active antivibration system			
Pick&Place holder kit with Praxis samples			
Glass tip puller with glass rods			
EXpressLO PGrids (Cu)			
EXpressLO-Z NCD grids	Option	al	
Aspirato (vacuum-assisted lift-out module)	Option	al	
Sample platen		sample m wafer	and

Installation requirements

Power supply	Power supply: 230 V 10% / 50 Hz (or 120 V /60 Hz-optional)	
Room for installation	2600 x 2300 mm	

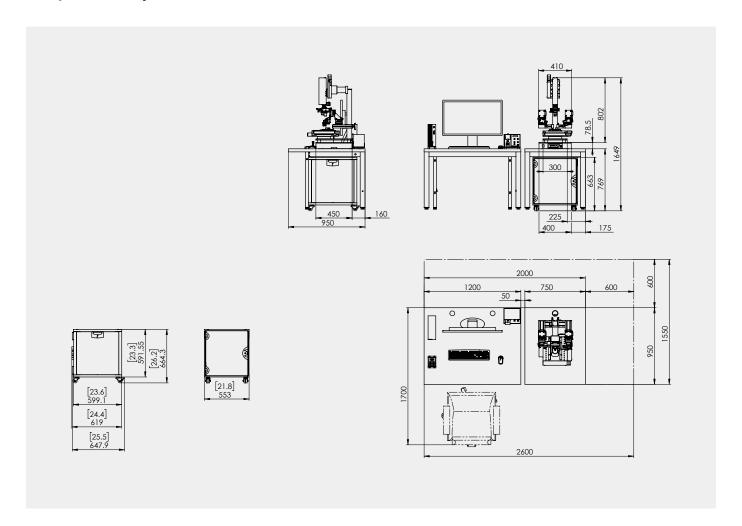
Environmental requirements

Temperature	17-24°C
Humidity	< 65 %
Vibrations	Vibrations: <10 µm/s below 30 Hz, < 20 µm/s above 30 Hz
Acoustic level	< 60 dBC

Training

Introductory: By TESCAN engineer after installation

Footprint of the system



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Technologies used are protected by patents, for instance US8,740,211; US8,789,828; US10,522,326; US10,801,928 ${\sf EXpressLO^{TM}, EXpressLO-Z^{TM}, Pick\&Place^{TM}, Aspirato^{TM}, Praxis^{TM}\ are\ trademarks\ of\ TESCAN\ GROUP, a.s.}$ We are constantly improving the performance of our products, so all specifications are subject to change without notice.

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TESCAN GROUP, a.s.

Libušina tř. 21, 623 00 Brno - Kohoutovice / Czech Republic (phone) +420 530 353 411 / (email) sales@tescan.com / marketing@tescan.com